

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

Low-Inductance

X5R / X7R 6.3 V TO 50 V

10 nF to I uF

RoHS compliant & Halogen Free



YAGEO Phicomp



SCOPE

This specification describes Midvoltage X7R series chip capacitors with lead-free terminations

APPLICATIONS

High speed IC packages
Processor package decoupling
AC noise reduction in multi-chip modules.

FEATURES

Supplied in tape on reel Nickel-barrier end termination RoHS compliant Halogen Free compliant

ORDERING INFORMATION - GLOBAL PART NUMBER, PHYCOMP

CTC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

CL <u>xxxx x x xxx x BB xxx</u> (1) (2) (3) (4) (5) (6)

(I) SIZE - INCH BASED (METRIC)

0204(0510)

0306(0816)

0508(1220)

0612(1632)

(2) TOLERANCE

 $K = \pm 10\%$

 $M = \pm 20\%$

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

K = Blister taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

F = Blister taping reel; Reel 13 inch

(4) TC MATERIAL

X5R / X7R

(5) RATED VOLTAGE

5 = 6.3 V

6 = 10 V

7 = 16 V

8 = 25 V

9 = 50 V

(6) CAPACITANCE VALUE

2 significant digits+number of zeros

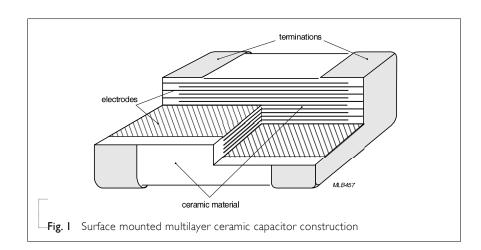
The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$

CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig. I.



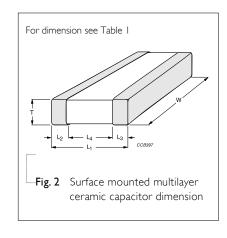
DIMENSION

Table I For outlines see fig. 2

		0				
TYPE	L _I (mm)	W (mm)	T (mm)	L_2 / L_3 min.	(mm) max.	L ₄ (mm)
					max.	111111.
0204	0.5 ±0.1	1.0 ±0.1	0.3 ±0.1	0.1	0.3	0.1
0306	0.8 ±0.15	1.6 ±0.2	0.5 ±0.1	0.1	0.3	0.2
0508	1.25 ±0.2	2.0 ±0.2	0.85 ±0.1	0.13	0.46	0.38
0612	1.6 ±0.2	3.2 ±0.2	0.85 ±0.1	0.13	0.46	0.50
0612*	1.6 ±0.2	3.2 ±0.2	1.15 ±0.1	0.13	0.46	0.50

0612*: luF/16V, 470nF~1uF/25V, 120nF~470nF/50V

OUTLINES





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CAPACITANCE RANGE & THICKNESS FOR X5R

Table 2	Sizes from	0204
---------	------------	------

CAP.	0204 6.3 V / 10V
10 nF	0.3 ±0.1
15 nF	0.3 ±0.1
22 nF	0.3 ±0.1
33 nF	0.3 ±0.1
47 nF	0.3 ±0.1
68 nF	0.3 ±0.1
100 nF	0.3 ±0.1
150 nF	
220 nF	
330 nF	
470 nF	
680 nF	
l uF	

NOTE

- I. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-6 series is on request
- 3. For special ordering code, please contact local sales force before order.

X5R, X7R

CAPACITANCE RANGE & THICKNESS FOR X7R

Table 3 Sizes from 0306 to 0508

CAP.	0306	0508		
	6.3 V / 10V	10 V	16 V	25 V
10 nF		0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
15 nF		0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
22 nF		0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
33 nF		0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
47 nF		0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
68 nF		0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
100 nF	0.5 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
150 nF		0.85 ±0.1	0.85 ±0.1	
220 nF	0.5 ±0.1	0.85 ±0.1	0.85 ±0.1	
330 nF				
470 nF		0.85 ±0.1		
680 nF				
I uF		0.85 ±0.1		

NOTE

- 1. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-6 series is on request
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CAPACITANCE RANGE & THICKNESS FOR X7R

Table4 Sizes from 0612

CAP.	0612				
	6.3 V	10 V	16 V	25 V	50 V
IO nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
15 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
22 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
33 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
47 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
68 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
100 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1
150 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	1.15 ±0.1	1.15 ±0.1
220 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	1.15 ±0.1	1.15 ±0.1
330 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	1.15 ±0.1	1.15 ±0.1
470 nF	0.85 ±0.1	0.85 ±0.1	0.85 ±0.1	1.15 ±0.1	1.15 ±0.1
680 nF	1.15 ±0.1	1.15 ±0.1	1.15 ±0.1	1.15 ±0.1	
l uF	1.15 ±0.1	1.15 ±0.1	1.15 ±0.1	1.15 ±0.1	

NOTE

- 1. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-6 series is on request
- 3. For special ordering code, please contact local sales force before order

THICKNESS CLASSES AND PACKING QUANTITY

Table 5

SIZE	THICKNESS	TAPE WIDTH -	Ø180 M1	1 / 7 INCH	Ø330 MN	1 / 13 INCH	QUANTITY
CODE	CLASSIFICATION	QUANTITY PER REEL	Paper	Blister	Paper	Blister	PER BULK CASE
0204	0.3 ±0.1 mm	8 mm	10,000				
0306	0.5 ±0.1 mm	8 mm	4,000		15,000		
0508	0.85 ±0.1 mm	8 mm	4,000		15,000		
0612	0.85 ±0.1 mm	8 mm	4,000		15,000		
0612	1.15 ±0.1 mm	8 mm		3,000			

ELECTRICAL CHARACTERISTICS

X7R DIELECTRIC CAPACITORS;

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C - Relative humidity: 25% to 75% - Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Surface-Mount Ceramic Multilayer Capacitors

Table 6	
DESCRIPTION	VALUE
Capacitance range	I0 nF to I uF
Capacitance tolerance	
X5R / X7R	±10%, ±20%
Dissipation factor (D.F.)	
X5R / X7R	≤5%
Insulation resistance after 1 minute at U _r (DC)	$R_{ins} \ge 10 \text{ G}\Omega$ or $R_{ins} \times C \ge 500$ seconds whichever is less
Maximum capacitance change as a function of temperature (temperature characteristic/coefficient):	
X5R / X7R	±15%
Operating temperature range:	
X5R	_55 °C to +85 °C
X7R	_55 °C to +125 °C

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X5R, X7R

6.3V to 50V

SOLDERING RECOMMENDATION

Table 7

SIZE SOLDERING

METHOD	0204	0306	0508	0612
Reflow				
Reflow/Wave	0	0	0	0

TESTS AND REQUIREMENTS

Table 8 Test procedures and requirements

TEST	TEST METHO	OD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual Inspection and Dimension Check		4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance		4.5.1	Class 2: f = 1 KHz, measuring at voltage 1 Vrms at 20 °C	Within specified tolerance
Dissipation Factor (D.F.)		4.5.2	Class 2: f = 1 KHz, measuring at voltage 1 Vrms at 20 °C	In accordance with specification
Insulation Resistance		4.5.3	At Ur (DC) for I minute	In accordance with specification

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X5R, X7R

TEST	TEST METHO	D	PROCED	DURE	REQUIREMENTS
Temperature coefficient	4.6		Capacitance shall be measured by the steps shown in the following table.		Class2: X7R/X5R : ∆ C/C : ±15%
				itance change should be measured after each specified temperature stage.	In case of applying voltage, the capacitance change should be measured after I more min.
			Step	Temperature(°C)	with applying voltage in equilibration of each temp. stage.
			a	25±2	terripi sunger
			b	Lower temperature±3°C	
			С	25±2	
			d	Upper Temperature±2°C	
			е	25±2	
			C1: Capad	: - CI × 100% CI xitance at step c citance at step b or d	
Adhesion	IEC 60384- 21/22	4.7		oplied for 10 seconds to the line joining nations and in a plane parallel to the	Force size ≥ 0306: 5N size = 0204: 2.5N
Bending Strength		4.8	Mounting paragraph	in accordance with IEC 60384-22 4.3	No visible damage
			Condition radius jig !	s: bending I mm at a rate of I mm/s, 5 mm	ΔC/C Class2: X7R/X5R : ±10%



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X5R, X7R

Product specification 10 6.3V to 50V 6.3V to 50V

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Resistance to Soldering Heat	4.9	4.9 Precondition: 150 +0/-10 °C for I hour, then keep for 24 ±1 hours at room	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned
		temperature Preheating: I20 °C to I50 °C for I minute and I70 °C to 200 °C for I minute.	ΔC/C Class2:
		Solder bath temperature: 260 ±5 °C	X7R/X5R:±10%
		Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours	D.F. within initial specified value R _{ins} within initial specified value
Solderability	4.10	Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination
		Test conditions for leadfree containing solder alloy	
		Temperature: 245 \pm 5 °C Dipping time: 3 \pm 0.3 seconds Depth of immersion: 10 mm	
Rapid Change of Temperature	IEC 4.11	Preconditioning; 150 +0/–10 °C for 1 hour, then keep for	No visual damage
•	21/22	24 ±1 hours at room temperature	ΔC/C
			Class2:
		5 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature	X7R/X5R:±15%
		Recovery time 24 ±2 hours	
		,	D.F. meet initial specified value
			R _{ins} meet initial specified value

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Damp Heat with Ur load	4.13	1. Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for 24 ± I hour at room temp 2. Initial measure: Spec: refer initial spec C, D, IR 3. Damp heat test:	No visual damage after recovery $ \Delta C/C $ Class2: $ \times 7R/\times 5R: \pm 20\% $ D.F.
		500 ±12 hours at 40 ±2 °C; 90 to 95% R.H; 1.0 Ur applied. 4. Recovery: Class 1: 6 to 24 hours Class 2: 24 ±2 hours 5. Final measure: C, D, IR	Class2: $X7R/X5R : \le 2 \times \text{ specified value}$ R_{ins} Class2: $X7R/X5R : \ge 500 \text{ M}\Omega \text{ or } R_{\text{ins}} \times C_r \ge 25s$ whichever is less
		P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to "IEC 60384 4.1" and then the requirement shall be met.	Δ C/C Class2: \times 7R/X5R: ±25% D.F. Class2: \times 7R/X5R: ≤ 2 × specified value Rins Rins × Cr ≥ 25 Ω · F

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X5R, X7R

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Endurance	IEC 60384- 21/22	4.14	 Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp 	No visual damage	
				ΔC/C	
			2. Initial measure:	Class2:	
			Spec: refer initial spec C, D, IR	X7R/X5R: ±20%	
			3. Endurance test:	D.F.	
			Temperature: NP0: 125 °C	Class2:	
			Specified stress voltage applied for 1,000	X7R/X5R : ≤ 2x initial value max	
			hours: Applied $2.0 \times U_r$ for general product	R _{ins}	
			Temperature: X7R: 125°C Specified stress voltage applied for 1,000 hours: Recovery time: 24 ±2 hours	Class2:	
				$X7R/X5R : \ge 1,000 \text{ M}\Omega \text{ or}$	
				Rins \times Cr \ge 50s whichever is less	
			4. Final measure: C, D, IR	Δ C/C	
			P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to "IEC 60384 4.1" and then the requirement shall be met.	Class2: X7R/X5R : ±25%	
				D.F.	
				Class2:	
				X7R/X5R : ≤ 2x initial value max	
				Rins	
			Class2:		
				Rins × Cr ≥ 50 Ω · F	
Voltage Proof	IEC 60384-1	4.5.4	Specified stress voltage applied for 1 to 5	No breakdown or flashover	
			seconds		
			$U_r \le 100 \text{ V: series applied 2.5 } U_r$		
			Charge/Discharge current less than 50mA		



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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version I	Nov. 7, 2016	-	- Add 13" packing
Version 0	Jun. 26, 2015	-	- New

Product specification 13 6.3V to 50V

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D55342E07B523DR-T/R NCA1206X7R103K50TRPF NCA1206X7R104K16TRPF NIN-FB391JTRF NIN-FC2R7JTRF

NMC0402NPO220J50TRPF NMC0402X5R105K6.3TRPF NMC0402X5R224K6.3TRPF NMC0402X7R103J25TRPF

NMC0402X7R153K16TRPF NMC0603NPO330G50TRPF NMC0603NPO331F50TRPF NMC0603X5R475M6.3TRPF

NMC0805NPO220J100TRPF NMC0805NPO270J50TRPF NMC0805NPO681F50TRPF NMC0805NPO820J50TRPF

NMC1206X7R102K50TRPF NMC1210Y5V105Z50TRPLPF NMC-H0805X7R472K250TRPF NMC-L0402NPO7R0C50TRPF NMC-L0603NPO2R2B50TRPF NMC-Q0402NPO8R2D200TRPF C1206C101J1GAC C1608C0G2A221J C1608X7R1E334K C2012C0G2A472J

2220J2K00562KXT KHC201E225M76N0T00 1812J2K00332KXT CCR06CG153FSV CDR14BP471CJUR CDR31BX103AKWR

CDR33BX683AKUS CGA2B2C0G1H010C CGA2B2C0G1H040C CGA2B2C0G1H050C CGA2B2C0G1H060D CGA2B2C0G1H070D

CGA2B2C0G1H120J CGA2B2C0G1H680J CGA2B2C0G1H1R5C CGA2B2C0G1H820J CGA2B2C0G1H390J CGA2B2C0G1H391J

CGA2B2C0G1H3R3C CGA2B2C0G1H680J CGA2B2C0G1H6R8D CGA2B2C0G1H820J CGA2B2X8R1H152K